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Suet Sandy To
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## Contents

<table>
<thead>
<tr>
<th>Session</th>
<th>Title</th>
<th>Page</th>
</tr>
</thead>
<tbody>
<tr>
<td>v</td>
<td>Authors</td>
<td></td>
</tr>
<tr>
<td>vi</td>
<td>Conference Committee</td>
<td></td>
</tr>
<tr>
<td>ix</td>
<td>Introduction</td>
<td></td>
</tr>
</tbody>
</table>

**SIXTH ASIA PACIFIC CONFERENCE ON OPTICS MANUFACTURE**

<table>
<thead>
<tr>
<th>Session</th>
<th>Title</th>
<th>Page</th>
</tr>
</thead>
<tbody>
<tr>
<td>11383 02</td>
<td>Binocular vision physical coordinate positioning algorithm based on PSO-Harris operator</td>
<td>[11383-5]</td>
</tr>
<tr>
<td>11383 03</td>
<td>Fabrication of multi-layer micropillars array in micro-grooving technology</td>
<td>[11383-8]</td>
</tr>
<tr>
<td>11383 04</td>
<td>Vibration-resistant interferometric measurement of optical surface figure and roughness</td>
<td>[11383-10]</td>
</tr>
<tr>
<td>11383 05</td>
<td>Dark field microscopy for ultra-precision surface processing defect measurement</td>
<td>[11383-11]</td>
</tr>
<tr>
<td>11383 06</td>
<td>Analysis and optimization for a chordwise morphing wing with clearance joints</td>
<td>[11383-12]</td>
</tr>
<tr>
<td>11383 07</td>
<td>Local field enhancement effect of the gold-coated nanoprobe</td>
<td>[11383-16]</td>
</tr>
<tr>
<td>11383 08</td>
<td>Detection and analysis of surface defects on polished KDP crystal</td>
<td>[11383-19]</td>
</tr>
<tr>
<td>11383 09</td>
<td>Modeling and experiment of concave microlens array on silicon wafer by grinding-polishing process with diamond slurry</td>
<td>[11383-20]</td>
</tr>
<tr>
<td>11383 0A</td>
<td>Focusing characteristics optimization of composite near-field fiber probe based on surface plasmon</td>
<td>[11383-21]</td>
</tr>
<tr>
<td>11383 0B</td>
<td>A single mirror magnifier with freeform surfaces using radial basis functions based on surface slope</td>
<td>[11383-22]</td>
</tr>
<tr>
<td>11383 0C</td>
<td>Research progress on optical system of polarization LIDAR</td>
<td>[11383-23]</td>
</tr>
<tr>
<td>11383 0D</td>
<td>An investigation of slurry erosion analysis for disc hydrodynamic polishing</td>
<td>[11383-24]</td>
</tr>
</tbody>
</table>
Authors

Numbers in the index correspond to the last two digits of the seven-digit citation identifier (CID) article numbering system used in Proceedings of SPIE. The first five digits reflect the volume number. Base 36 numbering is employed for the last two digits and indicates the order of articles within the volume. Numbers start with 00, 01, 02, 03, 04, 05, 06, 07, 08, 09, 0A, 0B...0Z, followed by 10-1Z, 20-2Z, etc.

Cao, Zhongchen, 0D
Chang, Jun, 0C
Cui, Hailong, 08
Ding, Jielong, 08
Guan, Lichao, 08
He, Y., 03
Huang, Wen, 04, 05
Jiang, Xiangmin, 0D
Lei, Tiancai, 08
Li, Bing, 06
Li, Dongmei, 0C
Li, Gang, 06
Li, Kailong, 0D
Li, Lulu, 04, 05
Li, Shaobo, 07, 0A
Liang, Zhiquiang, 09
Lin, Bin, 0D
Ling, Xiang, 02
Liu, Qian, 04, 05
Liu, Xiaohua, 09
Liu, Xin, 0C
Ning, Yinghao, 06
Shi, Guangwei, 0C
Song, Lipei, 0B
Tong, Kailian, 0B
Wang, Lingjie, 0B, 0C
Wang, S., 03
Wang, Sen, 06
Wang, Shuai, 06
Wang, Xiaomin, 0A
Wang, Xibin, 09
Wei, QianZhou, 02
Xia, S., 03
Xiao, Liuchang, 0B
Yang, Shuming, 07, 0A
Yang, Xiaokai, 07, 0A
Yi, Allen Y., 09
Yin, Qingfeng, 08
Zhang, Bo, 0B
Zhang, Xiaodong, 0B
Zhang, Yu, 02
Zhao, Xing, 0B
Zhao, Zhiliang, 04
Zhong, Yue, 0C
Zhou, Tianfeng, 09
Zhou, Wenchao, 09
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Introduction

On behalf of the Organizing Committee, we would like to present the proceedings of the Sixth Asia Pacific Conference on Optics Manufacture. The First Asia Pacific Conference on Optics Manufacture (APCOM 2007) was held in Hong Kong, then Taipei, Changchun, Guangzhou, and Shanghai. The sixth conference returned to Hong Kong and was organized by the State Key Laboratory of Ultraprecision Machining Technology (SKL of UMT) of The Hong Kong Polytechnic University. The SKL of UMT has been actively engaging in cutting-edge research in design, manufacturing, and measurement of freeform optical elements.

The conference is one of the fastest growing regions in terms of economics, education, and technology. We were so glad to witness that the number of scientists, engineers, and academics, as well as research institutes and companies involved in advanced optics manufacture has grown tremendously as compared with that ten years ago. The applications of optical components and products in various industries has become more widespread. There has also been significant advancement of technologies for design, manufacturing, and measurement of the optical elements and systems. The theme of this conference continues to provide an excellent opportunity and platform for academics and industries to discuss and exchange ideas and their research findings, while also enabling them to acquire knowledge of the latest developments of optics-related technologies.

We invited international well-known experts from different countries such as Australia, China, Germany, Singapore, the United Kingdom, United States, etc., to deliver keynote speeches and invited talks and companies supporting our conference to showcase their latest research achievements, technologies, and products.

We would like to express our sincere thanks to the co-organizers and sponsors for their support of the organization of the conference. We would also like to express our sincere thanks to K.C. Wong Foundation which provided financial support for the conference. I hope that all of you enjoyed the event, and that the spirit of collaboration among us will continue in the years to come.

Chi Fai Benny Cheung